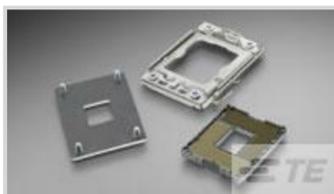




Connectors > Socket Connectors > IC & Component Socket Accessories > IC Socket Hardware



Compatible With IC Socket Type: **LGA 1366**

Card & Socket Accessory Type: **ILM**

Operating Temperature Range: **-25 – 100 °C [ -13 – 212 °F ]**

## Features

### Product Type Features

Socket Connector Accessory Type	Accessory
Card & Socket Accessory Type	ILM

### Body Features

Spring Plate Assembly Material	Stainless Steel
Top Support Plate Material	Stainless Steel
Backplate Material	Steel
Insulator Material	Polycarbonate Film Plus Acrylic Adhesive Layer

### Contact Features

Compatible With IC Socket Type	LGA 1366
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### Usage Conditions

Operating Temperature Range	-25 – 100 °C[-13 – 212 °F]
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### Packaging Features

Packaging Method	Bag/Box
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## Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224)

Candidate List Declared Against: JAN 2020  
(205)

SVHC > Threshold:

Pb (.35% in Component Part)

**Article Safe Usage Statements:**

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

**Product Compliance Disclaimer**

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Documents

### Product Drawings

[ILM COVER ASSY, LGA1366](#)

English

### CAD Files

[3D PDF](#)

3D

**Customer View Model**

[ENG\\_CVM\\_CVM\\_1939738-1\\_U.2d\\_dxf.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_CVM\\_1939738-1\\_U.3d\\_igs.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_CVM\\_1939738-1\\_U.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

### Datasheets & Catalog Pages

[Sockets\\_and\\_Hardware\\_for\\_LGA\\_1366\\_Processors](#)

English



**Product Specifications**

[Application Specification](#)

English

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**Product Environmental Compliance**

[TE Material Declaration](#)

English

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**Instruction Sheets**

[Instruction Sheet \(non U.S.\)](#)

English